PATENT APPLICATION Docket No. 9898-341 Client No. SS-18733-US

## COMBINED DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

is attached hereto.

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled MULTI-CHIP PACKAGE WITH SOFT ELEMENT AND METHOD OF MANUFACTURING THE SAME, the specification of which:

育	was filed on	as Application No.	
- H	and was amended on	(if applicable)	•——
님	with amendments through	(if applicable) gh (if applicable).	
	with amountainers through		
I hereby state specification, includ	e that I have reviewed and ing the claims, as amended	understand the contents of the abo I by any amendment referred to ab	ve-identified ove.
I acknowledgof this application in	ge the duty to disclose info	rmation which is material to the p Code of Federal Regulations, Sec	atentability 1.56.
(a)-(d) or §365(b) of of any PCT internat: United States of Aπ for natent or invento	f any foreign application(s) ional application which de- perion listed below and hay	under Title 35, United States Cod for patent or inventor's certificate signated at least one country other we also identified below any foreig CT international application havin iority is claimed:	e, or 9303(a) than the on application
Prior Foreign Appli	cation(s)		Claiming Priority?
2003- <u>11209</u> (Number)	Republic of Korea (Country)	22 February 2003 (Day/Month/Year Filed)	Yes No
I hereby clai United States provis	m the benefit under Title 3 sional application listed be	5, United States Code, Sec. 119(e	) of any
Provisional Application No.		Filing Date	
		***************************************	
I hereby clai	m the benefit under Title 3	5, United States Code, Sec. 120 of the United States of America lists	ed below and,

insofar as the subject matter of each of the claims of this application is not disclosed in the

prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Sec. 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, Sec. 1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application No.) (Filing Date) (Status) (patented, pending, abandoned)

I hereby appoint the following attorneys to prosecute the application, to file a corresponding international application, to prosecute and transact all business in the Patent and Trademark Office connected therewith:

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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